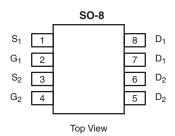


Vishay Siliconix

Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)			
- 20	0.0192 at V _{GS} = - 10 V	- 8	20			
- 20	0.0330 at V _{GS} = - 4.5 V	- 8	20			



Ordering Information: Si4943CDY-T1-E3 (Lead (Pb)-free)

Si4943CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

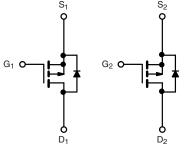
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

Pb-free



APPLICATIONS

- · Load Switching
 - Computer
 - Game Systems
- · Battery Switching
 - 2-Cell Li-Ion



P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless othe	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	- 20	V		
Gate-Source Voltage	V_{GS}	± 20	v		
	T _C = 25 °C		- 8 ^e		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C		- 8 ^e		
Continuous Diam Curient (1) = 130 C)	T _A = 25 °C	I _D	- 8 ^{b, c, e}		
	T _A = 70 °C		- 6.7 ^{b, c}		
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	- 30	Α	
Source-Drain Current Diode Current	T _C = 25 °C		- 2.5		
Source-Drain Current Diode Current	T _A = 25 °C	I _S	- 1.7 ^{b, c}		
Pulsed Sorce-Drain Current	I _{SM}	- 30			
Single Pulse Avalanche Current		I _{AS}	- 11		
Single-Pulse Avalanche Energy L = 0.1 mH		E _{AS}	6	mJ	
	T _C = 25 °C		3.1		
Maximum Dawar Dissination	T _C = 70 °C	P _D	2	W	
Maximum Power Dissipation	T _A = 25 °C	LD.	2 ^{b, c}		
	T _A = 70 °C		1.28 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 50 to 150	°C		

THERMAL RESISTANCE RATINGS						
		Li	Limit			
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	50	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	30	40	C/VV	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 110 $^{\circ}\text{C/W}.$
- e. Package Limited.

Si4943CDY

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 21		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.4			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			- 100	nA	
Zana Cata Valtana Busin Comunant	1	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}			- 10	μΑ		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = - 10 V	- 30			Α	
Davis Course Or Olate Besidens h		V _{GS} = - 10 V, I _D = - 8.3 A		0.0160	0.0192	Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 6.4 A		0.0275	0.0330		
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 10 V, I _D = - 8.3 A		19		S	
Dynamic ^a							
Input Capacitance	C _{iss}			1945		pF	
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		460			
Reverse Transfer Capacitance	C _{rss}			385			
Total Cata Charga	0	$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.3 \text{ A}$		41	62	nC	
Total Gate Charge	Q _g			20	30		
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -8.3 \text{ A}$		7			
Gate-Drain Charge	Q _{gd}			9			
Gate Resistance	R_g	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 1.5 \Omega$		11	17		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 6.7 A, V_{GEN} = - 10 V, R_g = 1 Ω		35	53		
Fall Time	t _f			10	15	no	
Turn-On Delay Time	t _{d(on)}			50	75	ns	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 1.5 \Omega$		71	107		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -6.7 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		29	44]	
Fall Time	t _f			15	23		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode	I _S	T _C = 25 °C			- 2.5		
Current		10 = 1			_	Α	
Pulse Diode Forward Current ^a	I _{SM}				- 30		
Body Diode Voltage	V _{SD}	I _S = - 6.7 A		- 0.77	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			30	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 6.7 A, dI/dt = 100 A/μs, T _J = 25 °C		17	26	nC	
Reverse Recovery Fall Time	t _a	, , , , , , , , , , , , , , , , , , , ,		13		ns	
Reverse Recovery Rise Time	t_b			17			

Notes:

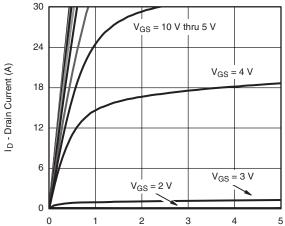
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

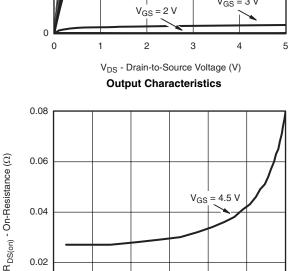
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





15 I_D - Drain Current (A)

10

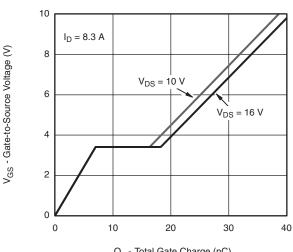
On-Resistance vs. Drain Current and Gate Voltage

 $V_{GS} = 10 \text{ V}$

20

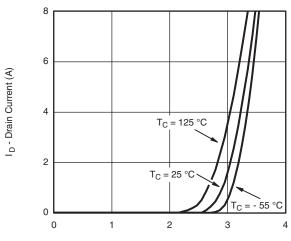
25

30



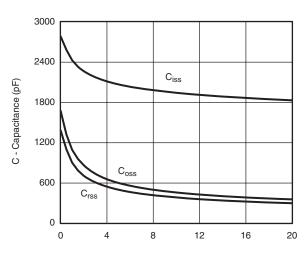
Q_q - Total Gate Charge (nC)

Gate Charge



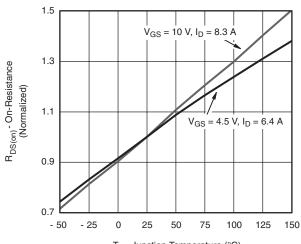
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V)

Capacitance



T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

0.02

0.00

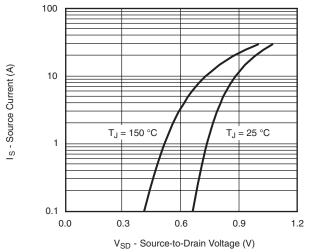
0

Si4943CDY

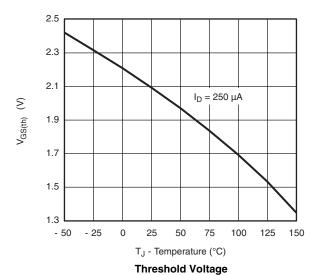
Vishay Siliconix

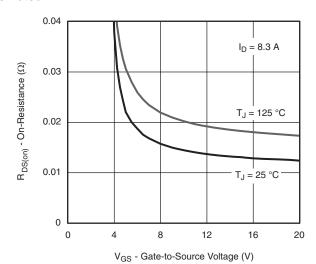
VISHAY

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

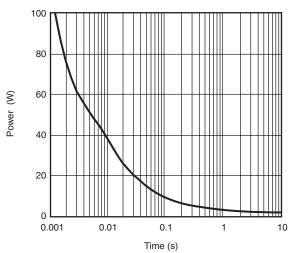


Source-Drain Diode Forward Voltage

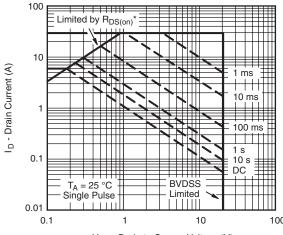




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



V_{DS} - Drain-to-Source Voltage (V)

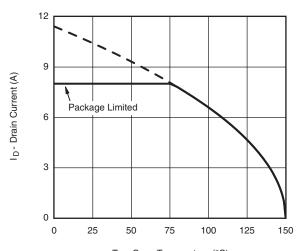
 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient



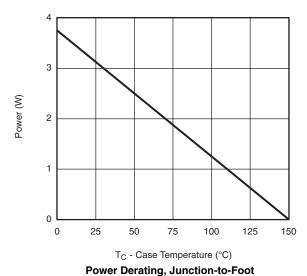
Vishay Siliconix

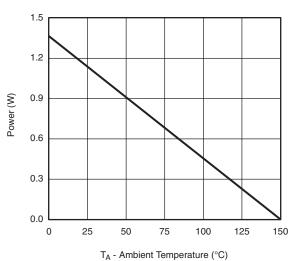
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*





Power Derating, Junction-to-Ambient

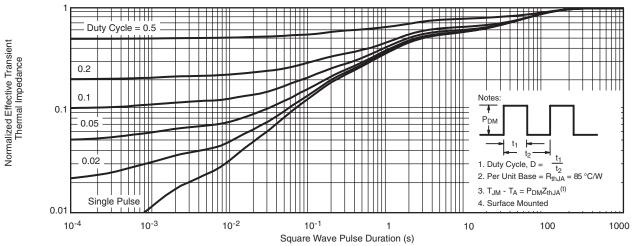
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

Si4943CDY

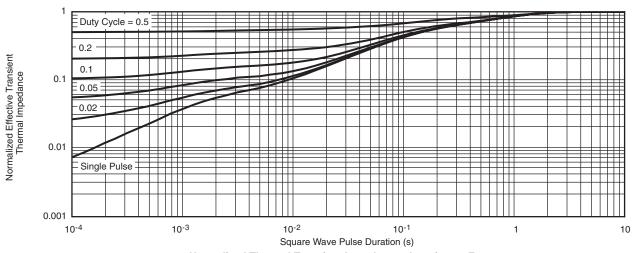
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050) BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384

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